

QUICKSWITCH[®] PRODUCTS 2.5V / 3.3V 32-BIT HIGH BANDWIDTH BUS SWITCH

DESCRIPTION:

terminals.

+85°C.

The QS34XVH2245 is a high bandwidth, 32-bit bus switch. The

QS34XVH2245 with 25 Ω resistance and 1.35ns propagation delay is

ideal for line matching and low noise environments. The switches can

be turned ON under the control of individual LVTTL-compatible Output

Enable (\overline{OEx}) signals for bidirectional data flow with no added delay or

ground bounce. In the ON state, the switches can pass signals up to 5V.

In the OFF state, the switches offer very high impedance at the

The combination of small propagation delay, high OFF impedance,

The QS34XVH2245 is characterized for operation from -40°C to

and over-voltage tolerance makes the QS34XVH2245 ideal for high

performance communications applications.

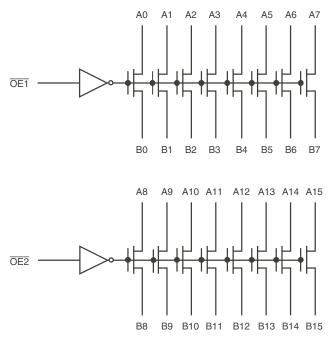
FEATURES:

- N channel FET switches with no parasitic diode to Vcc
 - Isolation under power-off conditions
 - No DC path to Vcc or GND
 - 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- Flat Row characteristics over operating range
- Rail-to-rail switching 0 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- Excellent Ron matching between channels
- Vcc operation: 2.3V to 3.6V
- · High bandwidth
- LVTTL-compatible control Inputs
- Undershoot Clamp Diodes on all switch and control Inputs
- · Low I/O capacitance, 4pF typical
- 25Ω resistors for low noise and line matching
- Available in 80-pin QVSOP package

APPLICATIONS:

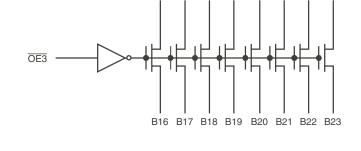
- Hot-swapping
- · Low distortion analog switch
- Replaces mechanical relay
- ATM 25/155 switching

FUNCTIONAL BLOCK DIAGRAM

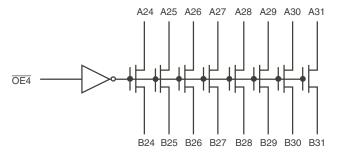


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INDUSTRIAL TEMPERATURE RANGE



A16 A17 A18 A19 A20 A21 A22 A23



JANUARY 2013

PIN CONFIGURATION

| | | \ | 1 | |
|-----|----|------------------|---|-------------------|
| NC | 1 | 80 | | Vcc |
| Ao | 2 | 79 | | 0E1 |
| A1 | 3 | 78 | | Bo |
| A2 | 4 | 77 | | Bı |
| Аз | 5 | 76 | | B2 |
| A4 | 6 | 75 | | Вз |
| A5 | 7 | 74 | | B4 |
| A6 | 8 | 73 | | B5 |
| A7 | 9 | 72 | | B6 |
| GND | 10 | 71 | | B7 |
| NC | 11 | 70 | | Vcc |
| A8 | 12 | 69 | | \overline{OE}_2 |
| A9 | 13 | 68 | | B8 |
| A10 | 14 | 67 | | B9 |
| A11 | 15 | 66 | | B10 |
| A12 | 16 | 65 | | B11 |
| A13 | 17 | 64 | | B12 |
| A14 | 18 | 63 | | B13 |
| A15 | 19 | 62 | | B14 |
| GND | 20 | 61 | | B15 |
| NC | 21 | 60 | | Vcc |
| A16 | 22 | 59 | | 0E3 |
| A17 | 23 | 58 | | B16 |
| A18 | 24 | 57 | | B17 |
| A19 | 25 | 56 | | B18 |
| A20 | 26 | 55 | | B19 |
| A21 | 27 | 54 | | B20 |
| A22 | 28 | 53 | | B21 |
| A23 | 29 | 52 | | B22 |
| GND | 30 | 51 | | B23 |
| NC | 31 | 50 | | Vcc |
| A24 | 32 | 49 | | \overline{OE}_4 |
| A25 | 33 | 48 | | B24 |
| A26 | 34 | 47 | | B25 |
| A27 | 35 | 46 | | B26 |
| A28 | 36 | 45 | | B27 |
| A29 | 37 | 44 | | B28 |
| A30 | 38 | 43 | | B29 |
| A31 | 39 | 42 | | B30 |
| GND | 40 | 41 | | B31 |
| | 1 | QVSOP OP VIEW | | |

INDUSTRIAL TEMPERATURE RANGE

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

| Symbol | Description | Max | Unit |
|----------------------|---|--------------|------|
| VTERM ⁽²⁾ | SupplyVoltage to Ground | -0.5 to +4.6 | V |
| VTERM ⁽³⁾ | DC Switch Voltage Vs | -0.5 to +5.5 | V |
| VTERM ⁽³⁾ | DC Input Voltage VIN | –0.5 to +5.5 | V |
| VAC | AC Input Voltage (pulse width ≤20ns) | -3 | V |
| Ιουτ | DC Output Current (max. sink current/pin) | 120 | mA |
| Tstg | Storage Temperature | -65 to +150 | °C |

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc terminals.

3. All terminals except Vcc .

CAPACITANCE (TA = +25°C, F = 1MHz, VIN = 0V, VOUT =

| 0 Symbol | Parameter ⁽¹⁾ | Тур. | Max. | Unit |
|-----------------|-----------------------------------|------|------|------|
| CIN | Control Inputs | 3 | 5 | pF |
| CI/O | Quickswitch Channels (Switch OFF) | 4 | 6 | pF |
| CI/O | Quickswitch Channels (Switch ON) | 8 | 12 | pF |

NOTE:

1. This parameter is guaranteed but not production tested.

PIN DESCRIPTION

| Pin Names | I/O | Description |
|-----------|-----|---------------|
| ŌĒx | I | Output Enable |
| Ax | I/O | Bus A |
| Bx | I/O | Bus B |

FUNCTION TABLE⁽¹⁾

| OEx | Function |
|-----|-------------------|
| н | Disconnected |
| L | Connect (Ax = Bx) |

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

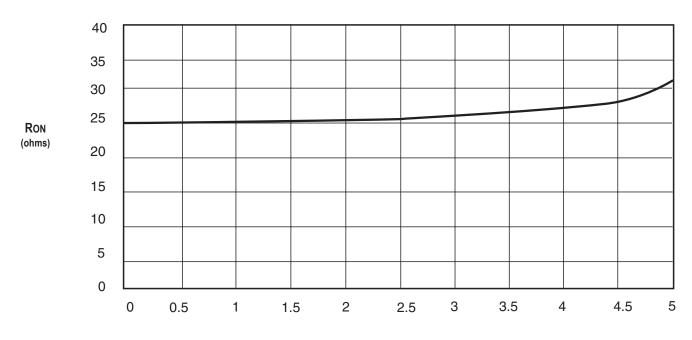
Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40° C to $+85^{\circ}$ C, Vcc = $3.3V \pm 0.3V$

| Symbol | Parameter | Test C | Conditions | | Min. | Typ. ⁽¹⁾ | Max. | Unit |
|--------|--|---|---|------------|------|---------------------|------|------|
| Vih | Input HIGH Voltage | Guaranteed Logic HIGH | Vcc = 2.3V to 2.7 | V | 1.7 | — | _ | V |
| | | for Control Inputs | Vcc = 2.7V to 3.6 | SV V | 2 | — | _ | |
| VIL | Input LOW Voltage | Guaranteed Logic LOW | Guaranteed Logic LOW Vcc = 2.3V to 2.7V | | — | _ | 0.7 | V |
| | | for Control Inputs | Vcc = 2.7V to 3.6 | SV | _ | — | 0.8 | 1 |
| lin | Input Leakage Current (Control Inputs) | $0V \le VIN \le VCC$ | | | — | _ | ±1 | μA |
| loz | Off-State Current (Hi-Z) | $0V \le VOUT \le 5V$, Switches OFF | | | _ | — | ±1 | μA |
| IOFF | Data Input/Output Power Off Leakage | VIN or VOUT 0V to 5V, Vcc = | 0V | | — | — | ±1 | μA |
| | | Vcc = 2.3V | VIN = 0V | Ion = 30mA | 18 | 27 | 39 | |
| Ron | Switch ON Resistance | Typical at Vcc = 2.5V VIN = 1.7V ION = 15mA | | 18 | 28 | 41 | Ω | |
| | | Vcc = 3V | VIN = 0V | Ion = 30mA | 18 | 25 | 38 |] |
| | | | VIN = 2.4V | Ion = 15mA | 18 | 26 | 40 | 1 |

NOTE:

1. Typical values are at Vcc = 3.3V and TA = $25^{\circ}C$.

TYPICAL ON RESISTANCE vs VIN AT Vcc = 3.3V



VIN (Volts)

INDUSTRIAL TEMPERATURE RANGE

POWER SUPPLY CHARACTERISTICS

| Symbol | Parameter | Test Conditions ⁽¹⁾ | Min. | Тур. | Max. | Unit |
|--------------|---|---|-------------|--------------|--------------|-------------|
| lccq | Quiescent Power Supply Current | Vcc = Max., VIN = GND or Vcc, f = 0 | - | 8 | 16 | mA |
| Δ ICC | Power Supply Current (2.3) per Input HIGH | Vcc = Max., VIN = 3V, f = 0 per Control Input | _ | - | 30 | μA |
| ICCD | Dynamic Power Supply Current per Output | Vcc = 3.3V, A and B Pins Open, Control Inputs | See Typical | ICCD vs Enab | le Frequency | graph below |
| | Enable Control Input ⁽⁴⁾ | Toggling @ 50% Duty Cycle | | | | |

NOTES:

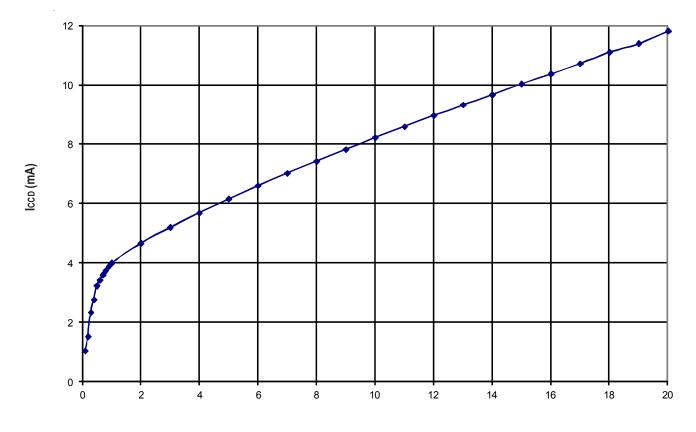
1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Per input driven at the specified level. A and B pins do not contribute to Δ Icc.

3. This parameter is guaranteed but not tested.

4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

TYPICAL ICCD vs ENABLE FREQUENCY CURVE AT VCC = 3.3V



ENABLE FREQUENCY (MHz)

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

T_A = -40°C to +85°C

| | | $Vcc = 2.5 \pm 0.2 V^{(1)}$ | | $Vcc = 3.3 \pm 0.3 V^{(1)}$ | | |
|--------------|---|-----------------------------|------|-----------------------------|------|------|
| Symbol | Parameter | Min. ⁽⁴⁾ | Max. | Min. ⁽⁴⁾ | Max. | Unit |
| t PLH | Data Propagation Delay ^(2,3) | | 0.9 | — | 1.35 | ns |
| t PHL | Ax to/from Bx | | | | | |
| tPZL | Switch Turn-On Delay | 1.5 | 9 | 1.5 | 8 | ns |
| tрzн | OEx to Ax/Bx | | | | | |
| tPLZ | Switch Turn-Off Delay | 1.5 | 7.5 | 1.5 | 7.5 | ns |
| t PHZ | OEx to Ax/Bx | | | | | |
| foex | Operating Frequency - Enable ^(2,5) | | 10 | | 20 | MHz |

NOTES:

1. See Test Conditions under TEST CIRCUITS AND WAVEFORMS.

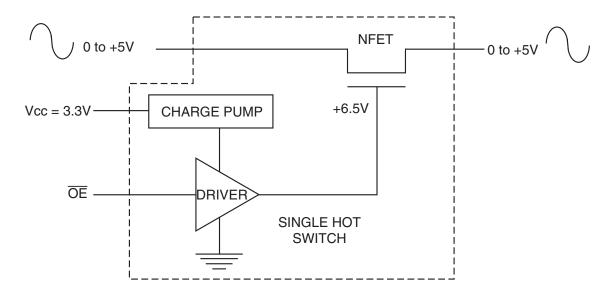
2. This parameter is guaranteed but not production tested.

3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 1.35ns at CL = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

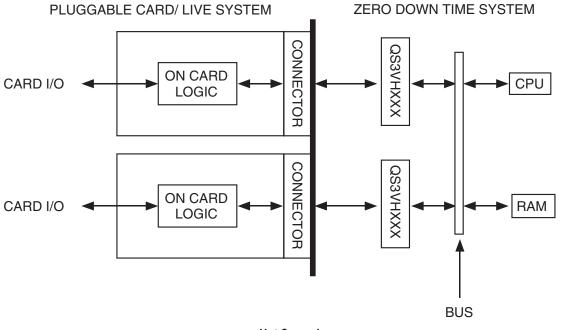
4. Minimums are guaranteed but not production tested.

5. Maximum toggle frequency for \overline{OEx} control input (pass voltage > Vcc, VIN = 5V, RLOAD $\ge 1M\Omega$, no CLOAD).

SOME APPLICATIONS FOR HOTSWITCH PRODUCTS



Rail-to-Rail Switching

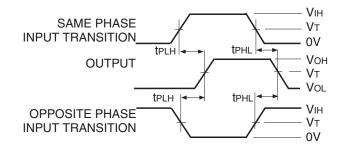


Hot-Swapping

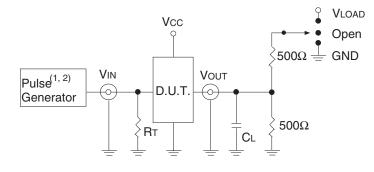
TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

| Symbol | $Vcc^{(1)}= 3.3V \pm 0.3V$ | $Vcc^{(2)} = 2.5V \pm 0.2V$ | Unit |
|--------|----------------------------|-----------------------------|------|
| Vload | 6 | 2 x Vcc | V |
| Vih | 3 | Vcc | V |
| Vt | 1.5 | Vcc/2 | V |
| Vlz | 300 | 150 | mV |
| Vнz | 300 | 150 | mV |
| CL | 50 | 30 | pF |



Propagation Delay



Test Circuits for All Outputs

DEFINITIONS:

 C_L = Load capacitance: includes jig and probe capacitance.

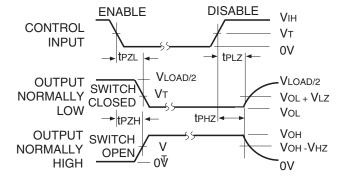
 $\mathsf{R} \mathsf{T}$ = Termination resistance: should be equal to $\mathsf{Z} \mathsf{O} \mathsf{U} \mathsf{T}$ of the Pulse Generator.

NOTES:

- 1. Pulse Generator for All Pulses: Rate \leq 10MHz; tr \leq 2.5ns; tr \leq 2.5ns.
- 2. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2ns; tR \leq 2ns.

SWITCH POSITION

| Test | Switch |
|-----------|--------|
| tplz/tpzl | Vload |
| tрнz/tpzн | GND |
| tPD | Open |

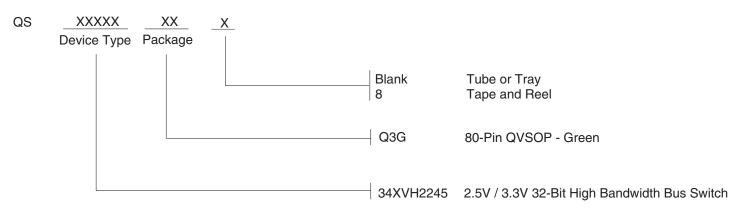


NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Enable and Disable Times

ORDERING INFORMATION



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